

20 V, complementary N/P-channel Trench MOSFET 28 June 2016 Product

Product data sheet

1. General description

Complementary N/P-channel enhancement mode Field-Effect Transistor (FET) in a leadless ultra small DFN1010B-6 (SOT1216) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Low leakage current
- Trench MOSFET technology
- Very low threshold voltage for portable applications: V_{GS(th)} = 0.7 V
- Leadless ultra small and ultra thin SMD plastic package: 1.1 × 1.0 × 0.37 mm
- ElectroStatic Discharge (ESD) protection > 1 kV HBM

3. Applications

- Relay driver
- High-speed line driver
- Level shifter
- Power management in battery-driven portables

4. Quick reference data

Table 1. Qu	uick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
TR1 (N-chan	TR1 (N-channel)							
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	20	V	
V _{GS}	gate-source voltage			-8	-	8	V	
I _D	drain current	V _{GS} = 4.5 V; T _{amb} = 25 °C	[1]	-	-	600	mA	
TR2 (P-chan	nel)							
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-20	V	
V _{GS}	gate-source voltage			-8	-	8	V	
TR1 (N-channel), Static characteristics								
R _{DSon}	drain-source on-state resistance	V _{GS} = 4.5 V; I _D = 600 mA; T _j = 25 °C		-	470	620	mΩ	

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².



5. Pinning information

Table 2	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source TR1		D1 D2
2	G1	gate TR1		
3	D2	drain TR2	2 5	
4	S2	source TR2		
5	G2	gate TR2	3 4	
6	D1	drain TR1	Transparent top view	S1 S2 017aaa262
7	D1	drain TR1	DFN1010B-6 (SOT1216)	
8	D2	drain TR2		

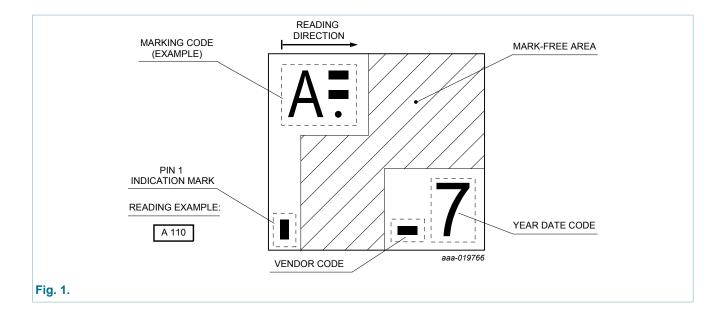
6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PMCXB900UEL	DFN1010B-6	DFN1010B-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals	SOT1216				

7. Marking

Table 4. Marking codes	
Type number	Marking code
PMCXB900UEL	B 110

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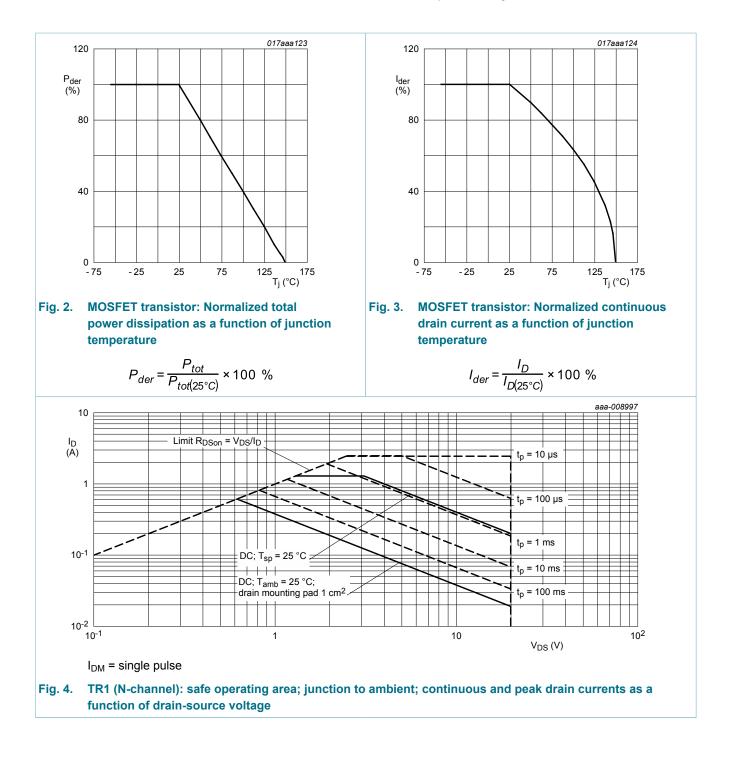
Limiting values 8.

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

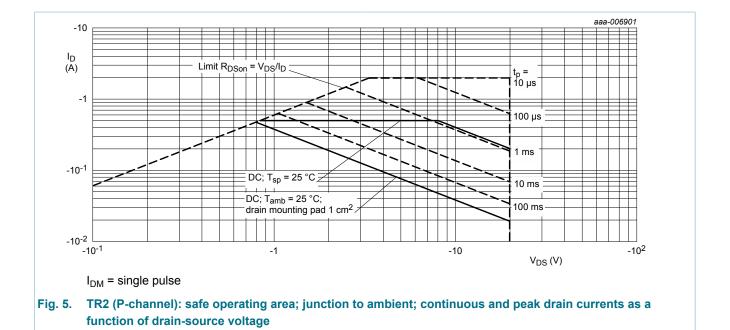
Symbol	Parameter	Conditions		Min	Max	Unit
TR1 (N-cha	nnel)					-
V _{DS}	drain-source voltage	T _j = 25 °C		-	20	V
V _{GS}	gate-source voltage			-8	8	V
I _D	drain current V_{GS} = 4.5 V; T_{amb} = 25 °C		[1]	-	600	mA
		V_{GS} = 4.5 V; T_{amb} = 100 °C	[1]	-	400	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	2.5	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	265	mW
			[1]	-	380	mW
		T _{sp} = 25 °C		-	4025	mW
TR2 (P-cha	nnel)					
V _{DS}	drain-source voltage	T _j = 25 °C		-	-20	V
V _{GS}	gate-source voltage			-8	8	V
I _D drain current	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-500	mA
		V_{GS} = -4.5 V; T_{amb} = 100 °C	[1]	-	-300	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-2	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	265	mW
			[1]	-	380	mW
		T _{sp} = 25 °C		-	4025	mW
Per device				1		
T _j	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
TR1 (N-cha	nnel), Source-drain diode			1		
I _S	source current	T _{amb} = 25 °C	[1]	-	400	mA
TR2 (P-cha	nnel), Source-drain diode					
I _S	source current	T _{amb} = 25 °C	[1]	-	-350	mA

 Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².
 Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



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9. Thermal characteristics

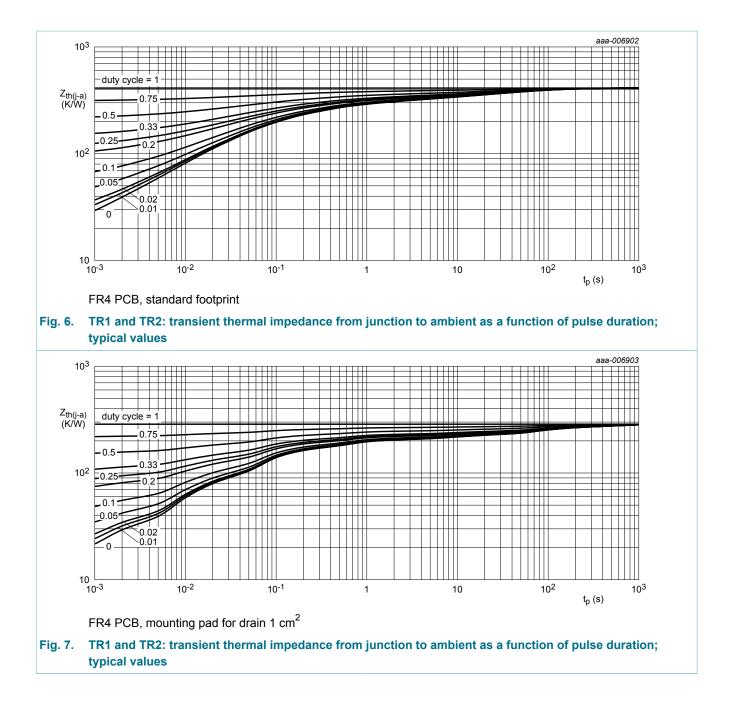
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-cha	innel)						_
R _{th(j-a)}	thermal resistance	in free air	[1]	-	410	475	K/W
	from junction to ambient		[2]	-	285	330	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	27	31	K/W
TR2 (P-cha	nnel)						
R _{th(j-a)}	thermal resistance	in free air	[1]	-	410	475	K/W
	from junction to ambient		[2]	-	285	330	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	27	31	K/W

[1] Device mounted on an FR4 PCB, single-sided copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

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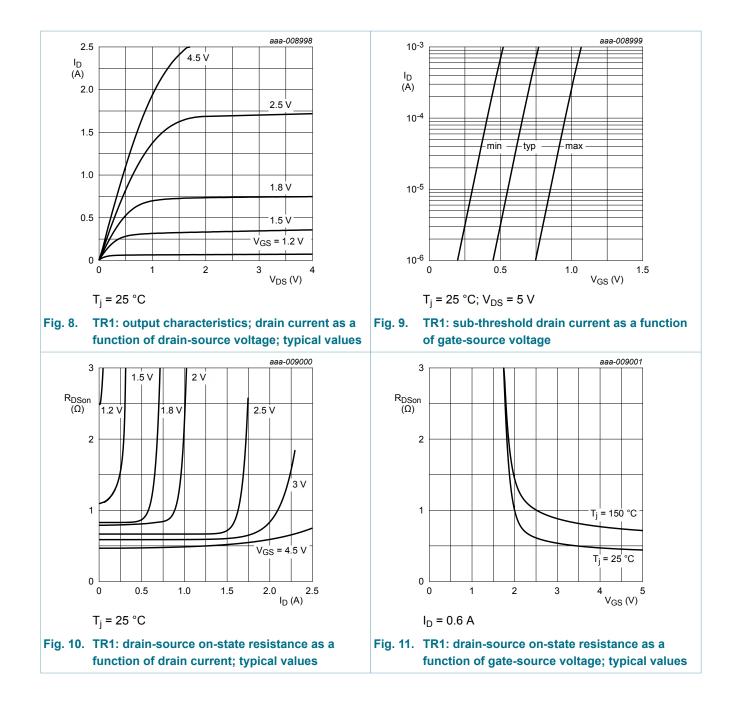


10. Characteristics

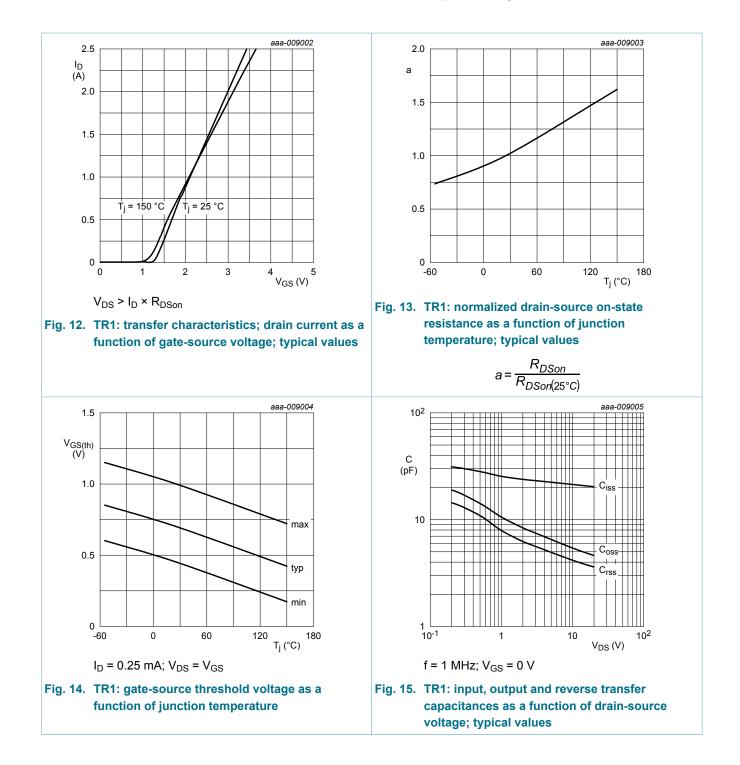
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (N-cha	nnel), Static characteristic	S				
V _{(BR)DSS}	drain-source breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C	20	-	-	V
V _{GSth}	gate-source threshold voltage	I _D = 250 μA; V _{DS} =V _{GS} ; T _j = 25 °C	0.45	0.7	0.95	V
I _{DSS}	drain leakage current	V_{DS} = 20 V; V_{GS} = 0 V; T_j = 25 °C	-	-	1	μA
		V_{DS} = 5 V; V_{GS} = 0 V; T_j = 25 °C	-	-	25	nA
I _{GSS}	gate leakage current	V _{GS} = 8 V; V _{DS} = 0 V; T _j = 25 °C	-	-	10	μA
		V _{GS} = -8 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-10	μA
		V_{GS} = 4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	1	μA
		V_{GS} = -4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-1	μA
		V_{GS} = 1.8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	50	nA
		V _{GS} = -1.8 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-50	nA
R _{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I _D = 600 mA; T _j = 25 °C	-	470	620	mΩ
resi		V _{GS} = 4.5 V; I _D = 600 mA; T _j = 150 °C	-	760	1000	mΩ
		V _{GS} = 2.5 V; I _D = 500 mA; T _j = 25 °C	-	620	850	mΩ
		V _{GS} = 1.8 V; I _D = 100 mA; T _j = 25 °C	-	845	1300	mΩ
		V _{GS} = 1.5 V; I _D = 10 mA; T _j = 25 °C	-	1125	3000	mΩ
		V _{GS} = 1.2 V; I _D = 1 mA; T _j = 25 °C	-	2210	-	mΩ
9 _{fs}	forward transconductance	V_{DS} = 5 V; I _D = 600 mA; T _j = 25 °C	-	1	-	S
TR2 (P-chai	nnel), Static characteristic	S	I			
V _{(BR)DSS}	drain-source breakdown voltage	I _D = -250 μA; V _{GS} = 0 V; T _j = 25 °C	-20	-	-	V
V _{GSth}	gate-source threshold voltage	I _D = -250 μA; V _{DS} =V _{GS} ; T _j = 25 °C	-0.45	-0.7	-0.95	V
I _{DSS}	drain leakage current	V_{DS} = -20 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-1	μA
		V_{DS} = -5 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-25	nA
I _{GSS}	gate leakage current	V_{GS} = 8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	10	μA
		V_{GS} = -8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-10	μA
		V_{GS} = 4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	1	μA
		V_{GS} = -4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-1	μA
		V_{GS} = 1.8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	50	nA
		V _{GS} = -1.8 V; V _{DS} = 0 V; T _i = 25 °C	-	-	-50	nA

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{DSon}	drain-source on-state	V_{GS} = -4.5 V; I _D = -500 mA; T _j = 25 °C	-	1.02	1.4	Ω
	resistance	V _{GS} = -4.5 V; I _D = -500 mA; T _j = 150 °C	-	1.54	2.1	Ω
		V_{GS} = -2.5 V; I _D = -200 mA; T _j = 25 °C	-	1.27	2.2	Ω
		V_{GS} = -1.8 V; I _D = -40 mA; T _j = 25 °C	-	1.7	3.3	Ω
		V_{GS} = -1.5 V; I _D = -10 mA; T _j = 25 °C	-	2.3	5	Ω
		V _{GS} = -1.2 V; I _D = -1 mA; T _j = 25 °C	-	3.5	-	Ω
9fs	forward transconductance	V _{DS} = -10 V; I _D = -500 mA; T _j = 25 °C	-	480	-	mS
TR1 (N-cha	nnel), Dynamic characteri	stics	I		1	
Q _{G(tot)}	total gate charge	V_{DS} = 10 V; I _D = 600 mA; V _{GS} = 4.5 V;	-	0.4	0.7	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	0.1	-	nC
Q _{GD}	gate-drain charge		-	0.1	-	nC
C _{iss}	input capacitance	V_{DS} = 10 V; f = 1 MHz; V_{GS} = 0 V;	-	21.3	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	5.4	-	pF
C _{rss}	reverse transfer capacitance		-	4.2	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 10 V; I _D = 600 mA; V _{GS} = 4.5 V;	-	5.6	-	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	9.2	-	ns
t _{d(off)}	turn-off delay time		-	19	-	ns
t _f	fall time		-	51	-	ns
TR2 (P-cha	nnel), Dynamic characteri	stics			1	
Q _{G(tot)}	total gate charge	V _{DS} = -10 V; I _D = -450 mA;	-	1.19	2.1	nC
Q _{GS}	gate-source charge	V _{GS} = -4.5 V; T _j = 25 °C	-	0.17	-	nC
Q _{GD}	gate-drain charge		-	0.1	-	nC
C _{iss}	input capacitance	V_{DS} = -10 V; f = 1 MHz; V_{GS} = 0 V;	-	43	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	14	-	pF
C _{rss}	reverse transfer capacitance		-	8	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = -10 V; I _D = -450 mA;	-	2.3	-	ns
t _r	rise time	$V_{GS} = -4.5 \text{ V}; \text{ R}_{G(ext)} = 6 \Omega; \text{ T}_{j} = 25 ^{\circ}\text{C}$	-	5	-	ns
t _{d(off)}	turn-off delay time		-	13.5	-	ns
t _f	fall time		-	6	-	ns
TR1 (N-cha	nnel), Source-drain diode	characteristics	1			
V _{SD}	source-drain voltage	$I_{\rm S}$ = 360 mA; $V_{\rm GS}$ = 0 V; $T_{\rm j}$ = 25 °C	-	0.8	1.2	V
TR2 (P-cha	nnel), Source-drain diode	characteristics	I		1	
V _{SD}	source-drain voltage	I _S = -115 mA; V _{GS} = 0 V; T _i = 25 °C	_	-0.7	-1.2	V

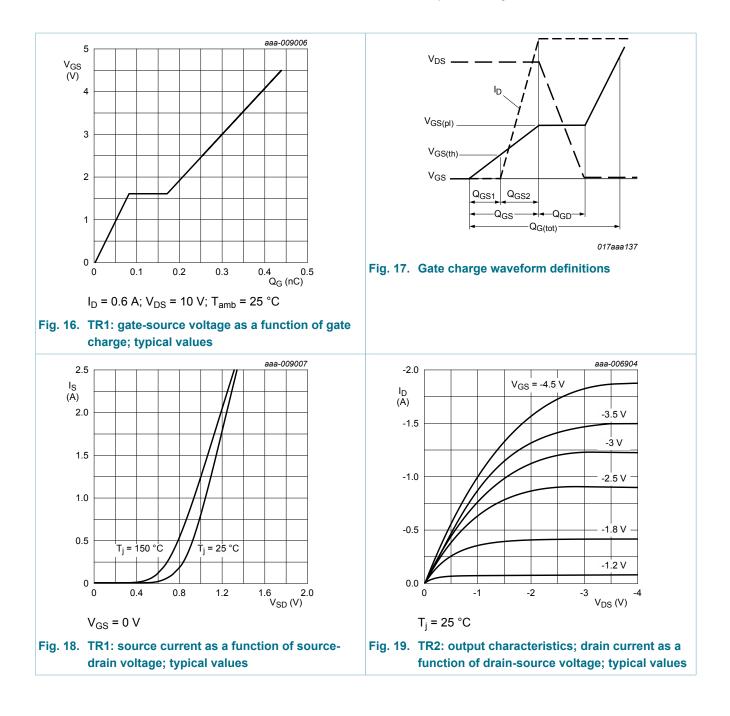
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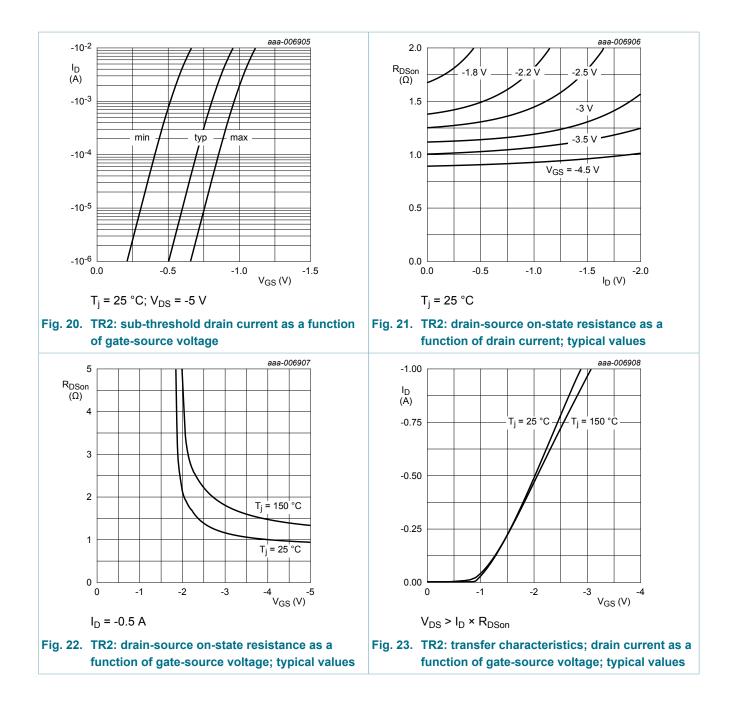


PMCXB900UEL



PMCXB900UEL

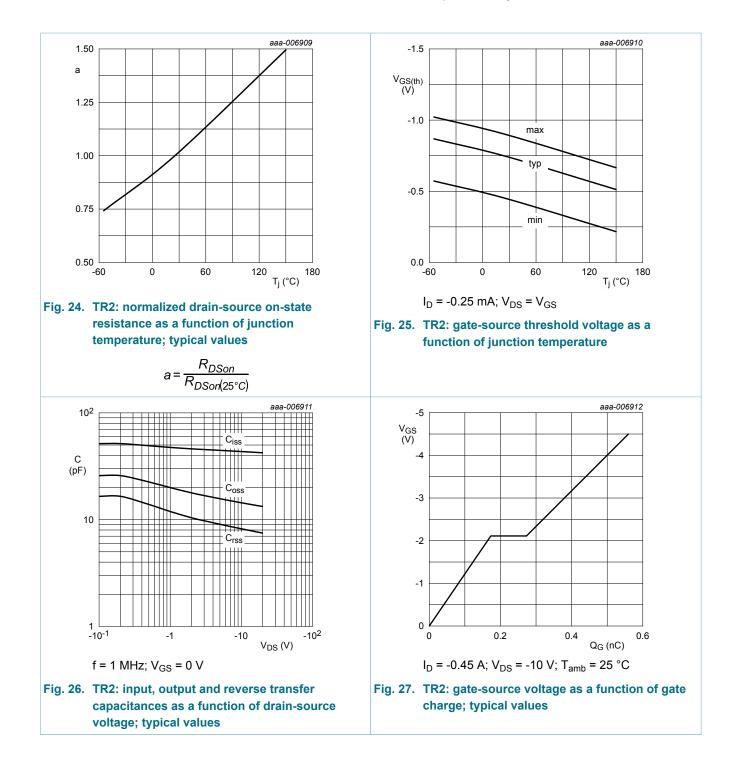
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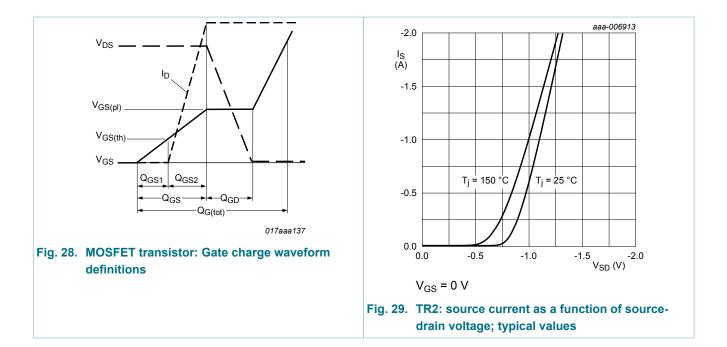
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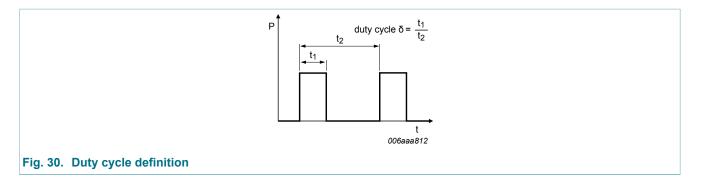


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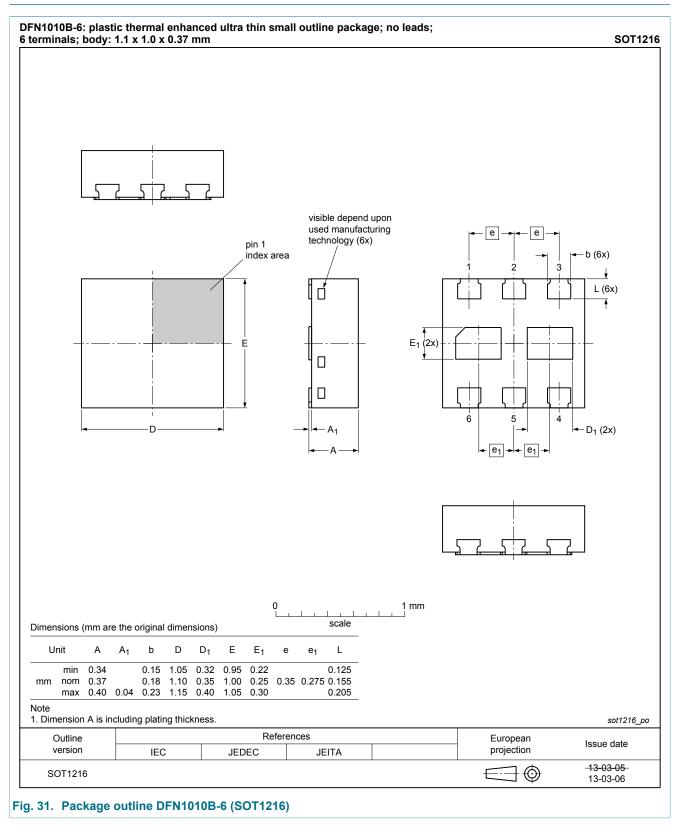


11. Test information

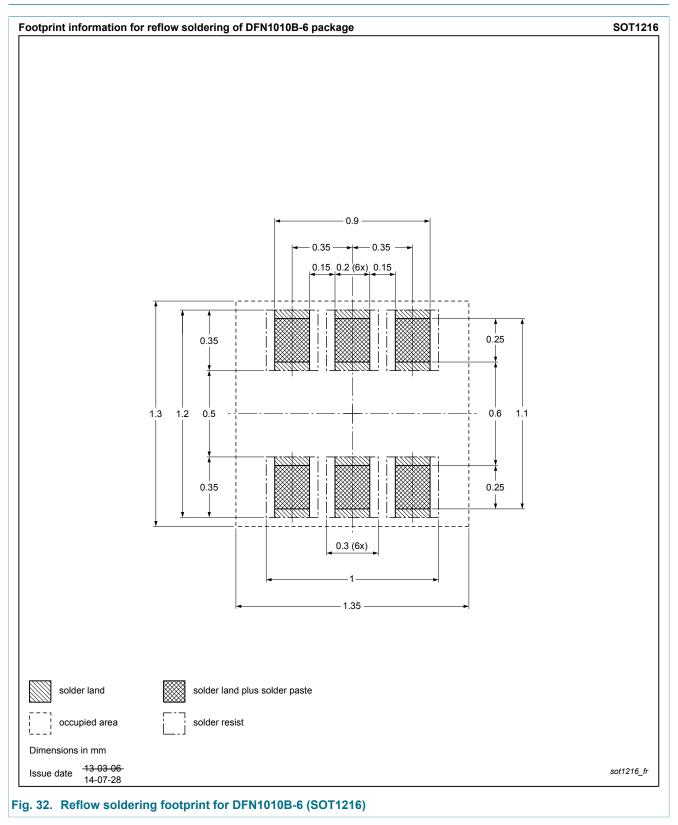


20 V, complementary N/P-channel Trench MOSFET

12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMCXB900UEL v.1	20160628	Product data sheet	-	-			

20 V, complementary N/P-channel Trench MOSFET

15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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